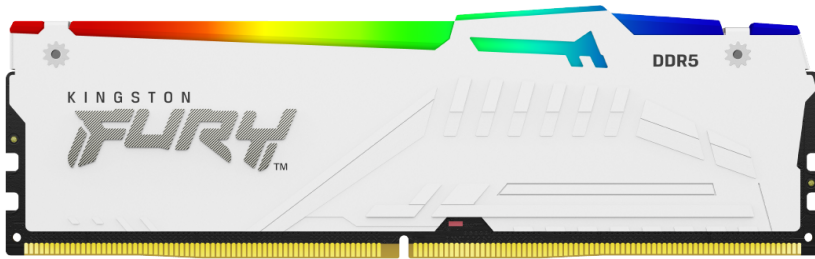


Memory Module Specifications

KF564C32BWAK2-32

32GB (16GB 2G x 64-Bit x 2 pcs.)
DDR5-6400 CL32 288-Pin DIMM Kit



DEFAULT SPECIFICATIONS

CL(IDD)	40 cycles
Row Cycle Time (tRCmin)	48ns(min.)
Refresh to Active/Refresh Command Time (tRFCmin)	295ns(min.)
Row Active Time (tRASmin)	32ns(min.)
UL Rating	94 V - 0
Operating Temperature	0° C to +85° C
Storage Temperature	-55° C to +100° C

DESCRIPTION

Kingston FURY KF564C32BWAK2-32 is a kit of two 2G x 64-bit (16GB) DDR5-6400 CL32 SDRAM (Synchronous DRAM) 1Rx8, memory module, based on eight 2G x 8-bit FBGA components per module. Each module kit supports Intel® Extreme Memory Profiles (Intel® XMP) 3.0. Total kit capacity is 32GB. Each module has been tested to run at DDR5-6400 at a low latency timing of 32-39-39 at 1.4V. The SPDs are programmed to JEDEC standard latency DDR5-4800 timing of 40-39-39 at 1.1V. Each 288-pin DIMM uses gold contact fingers. The JEDEC standard electrical and mechanical specifications are as follows:

DEFAULT FEATURES

- Power Supply: VDD = 1.1V Typical
- VDDQ = 1.1V Typical
- VPP = 1.8V Typical
- VDDSPD = 1.8V to 2.0V
- On-Die ECC
- Height 1.66" (42.23mm), w/heatsink

FACTORY TIMING PARAMETERS

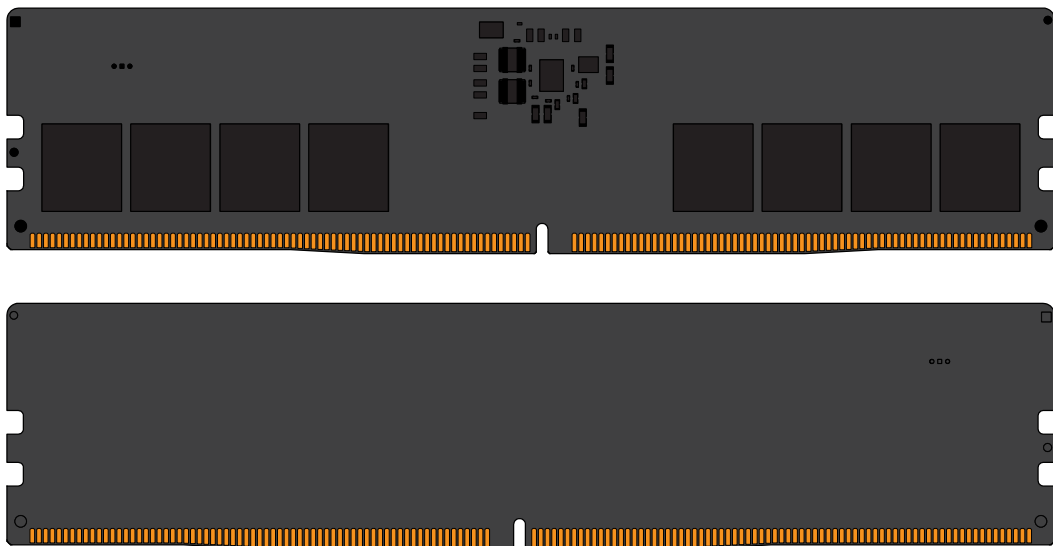
- Default (JEDEC): DDR5-4800 CL40-39-39 @1.1V
- XMP Profile #1: DDR5-6400 CL32-39-39 @1.4V
- XMP Profile #2: DDR5-6000 CL30-36-36 @1.4V
- XMP Profile #3: DDR5-4800 CL38-38-38 @1.1V

Continued >>

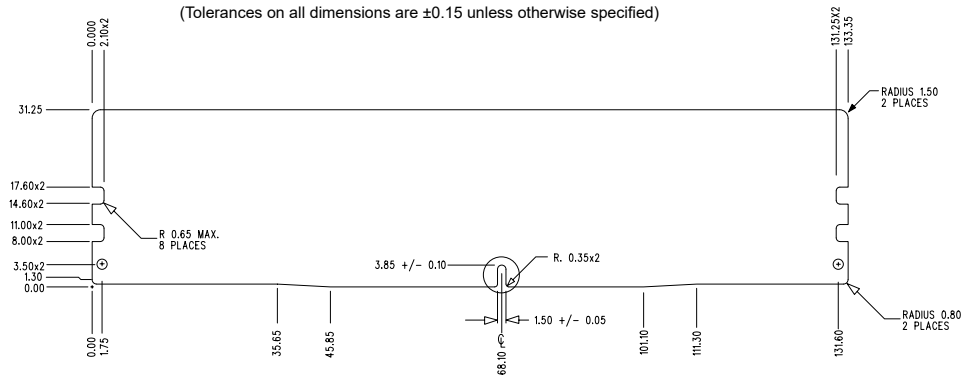
MODULE WITH HEAT SPREADER



MODULE DIMENSIONS



All measurements are in millimeters.
(Tolerances on all dimensions are ± 0.15 unless otherwise specified)



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FOR MORE INFORMATION, GO TO KINGSTON.COM

All Kingston products are tested to meet our published specifications. Some motherboards or system configurations may not operate at the published Kingston FURY memory speeds and timing settings. Kingston does not recommend that any user attempt to run their computers faster than the published speed. Overclocking or modifying your system timing may result in damage to computer components.

Revision No.	History	Release Date	Remark	Editor	Approved
A	Initial Release	02/27/24		David Y.	Alex S.

*Products and specifications discussed herein are for evaluation and reference purposes only and are subject to change without notice. All information discussed herein is provided on an “as is” basis, without warranties of any kind.